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Q.1

SARDAR PATEL UNIVERSITY

M.Sc. (Physics)(IIIrd Semester) Examination

Date : 23/04/2015, Day : Thursday, Time : 2:30 p.m. to 5:30 p.m.

Subject : Nanoscience and Thin film Physics, Paper No. PS03CPHY02

CBCS(choice based credit system)

Important Note : Q.1 : Multiple choice questions (MCQ) carries one mark each. Q.2 : Short questions carries two marks each (attempt any seven out of nine) Q.3 to Q.6 : Long questions carries 12 marks .

Sec. Sec. Sec.

Total Marks: 70

(8)

Choose the appropriate options from the following in Q.1 Which of the following methods of thin preparation is used to prepare i) insulating thin films (a) DC sputtering (b) thermal evaporation (c) RF Magnetron sputtering (d) none of these The confinement (D is for dimension) of electrons in carbon nanotubes ii) is in (d) 0D (c) 3D (b) 2D (a)1D Which of the following process is involved in the vapor phase epitaxy? iii) (b) diffusion (c) ion implantation (a)chemical vapor deposition (d) physical vapor Deposition In capillarity model, to form condensed phase i.e stable aggregates iv) from the supersaturated vapour we require supersaturation (d) infinite (c) greater than unity (b) zero (a) less than unity STM tip is made up of which type of material v) (b) platinum-iridium (a) iron-nickel (d) nickel-cobalt (c) nickel -chromium

Which of the following technique can be used to determine the vi) thickness of thin films in-situ (d) FET (b) Stylus profilometry (c) FECO (a) OCTM

In which of the chemical characterization techniques for thin films, the vii) three electron energy states are involved to produce the signature of element under observation? (d) SEM (c) XPS (a)RBS (b) AES

The most suitable material for MEMS is viii) (d) diamond (c) Si (b) Ge (a) GaAs

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Q.2		Answer any seven questions out of nine in Q.2	(14)
	i)	What is AFM ? What information you can get with the help of it and also mention different modes of AFM.	
	ii)	State the basic principle of Raman spectroscopy.	
	iii)	State merits and limitations of e-beam evaporation technique.	
	iv)	Define the terms adsorption, desorption and thermal accommodation.	
	v)	How XRD from thin films is obtained ? Explain.	
	vi)	Differentiate between capillarity and atomistic model.	
	vii)	Write advantages of thin film solar cells over crystalline solar cells	
	viii) ix)	State Stoke-Einstein's relationship used to determine the particle size. What are the limitations of determining particle size using this expression. What is epitaxial growth of thin films? Explain and mention different	
	INJ	methods used for it.	
Q.3(a) Q.3(b)	fa D	sing schematic diagrams explain how quantum dot lasers can be bricated. escribe the techniques known to you for synthesizing carbon nanotubes laboratory scale.	(6)
Q.3(b)		OR Splain the basic principle, construction and working of scanning nneling microscope.	(6)
Q.4(a)		xplain capillarity model and obtain the expression for critical nucleus and acleation rate.	(6)
Q.4(b)	Di	scuss four stages of thin film growth.	(6)
		OR	
Q.4(b)		hat is lithography ? Explain different steps involved to form quantum ots using photolithography	(6)

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- **O.5(a)** Explain PECVD technique used for depositing thin films. (6)
- Q.5(b) Why Radiofrequency technique is preferred over DC sputtering for depositing dielectric films ?. Explain RF sputtering in detail.

OR

- Q.5(b) What is meant by epitaxy ? Discuss molecular beam epitaxy technique to (6) form a monolayer film.
- Q.6(a) Describe the construction and working of scanning electron (6) microscope(SEM).
- Q.6(b) What are NEMS and MEMS? What is System on Chip-SOC? Justify the (6) use of Si for these devices.

OR

Q.6(b) Explain Rutherford back scattering technique in detail. (6)

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